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Silicon N-Channel MOS FET



ADE-208-1360 (Z) 1st. Edition Mar. 2001

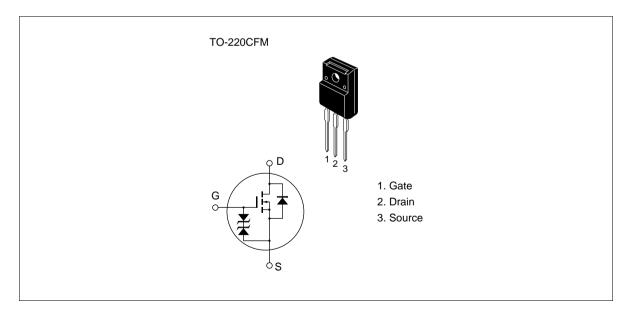
Application

High speed power switching

Features

- Low on-resistance
- High speed switching
- Low drive current
- No Secondary Breakdown
- Suitable for Switching regulator, DC-DC converter.

Outline



Absolute Maximum Ratings (Ta = 25°C)

Item	Symbol	Ratings	Unit
Drain to source voltage	V _{DSS}	250	V
Gate to source voltage	V _{GSS}	±30	V
Drain current	I _D	7	A
Drain peak current	I D(pulse) *1	28	A
Body to drain diode reverse drain current	I _{DR}	7	А
Channel dissipation	Pch*2	30	W
Channel temperature	Tch	150	°C
Storage temperature	Tstg	-55 to +150	°C

Notes 1. PW 10 µs, duty cycle 1 %

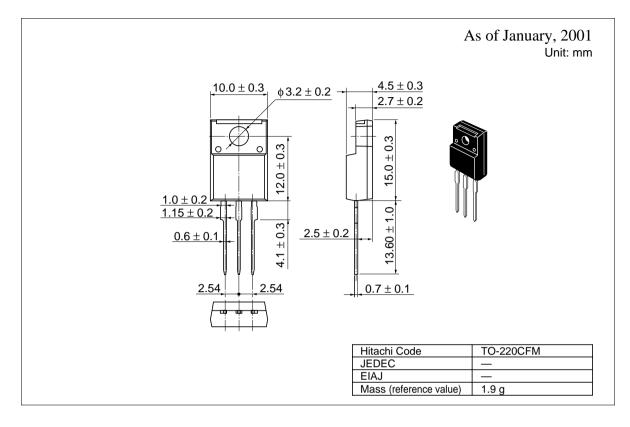
2. Value at Tc = $25 \degree C$

Electrical Characteristics (Ta = 25°C)

Item	Symbol	Min	Тур	Max	Unit	Test Conditions
Drain to source breakdown voltage	$V_{(\text{BR})\text{DSS}}$	250	_	_	V	$I_{\rm D} = 10$ mA, $V_{\rm GS} = 0$
Gate to source breakdown voltage	$V_{(BR)GSS}$	±30	_	_	V	$I_{g} = \pm 100 \ \mu A, \ V_{DS} = 0$
Gate to source leak current	I _{GSS}	—	—	±10	μA	$V_{GS} = \pm 25 \text{ V}, V_{DS} = 0$
Zero gate voltage drain current	I _{DSS}	—	—	250	μA	$V_{\rm DS}$ =250 V, $V_{\rm GS}$ = 0
Gate to source cutoff voltage	$V_{GS(off)}$	2.0	—	3.0	V	$I_{\rm D} = 1 \text{ mA}, V_{\rm DS} = 10 \text{ V}$
Static drain to source on state resistance	$R_{\text{DS(on)}}$	_	0.4	0.55		$I_{\rm D} = 4 \text{ A}$ $V_{\rm GS} = 10 \text{ V}^{*1}$
Forward transfer admittance	y _{fs}	3.0	5.0	_	S	$I_{\rm D} = 4 \text{ A}$ $V_{\rm DS} = 10 \text{ V}^{*1}$
Input capacitance	Ciss	—	690	_	pF	V _{DS} = 10 V
Output capacitance	Coss	—	265	—	pF	$V_{GS} = 0$
Reverse transfer capacitance	Crss	—	45	—	pF	f = 1 MHz
Turn-on delay time	t _{d(on)}	—	13	_	ns	$I_{D} = 4 A$
Rise time	t,	_	55	_	ns	V _{GS} = 10 V
Turn-off delay time	t _{d(off)}	—	65	_	ns	R _L = 7.5
Fall time	t _f	_	37	_	ns	
Body to drain diode forward voltage	V_{DF}	—	1.0	_	V	$I_{\rm F} = 7$ A, $V_{\rm GS} = 0$
Body to drain diode reverse recovery time	t _{rr}		180		ns	$I_{F} = 7 \text{ A}, V_{GS} = 0,$ $di_{F} / dt = 100 \text{ A} / \mu \text{s}$

See characteristics curves of 2SK1667, 2SK1668.

Package Dimensions



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